

ES2G

2.0A SURFACE MOUNT SUPER-FAST RECTIFIER

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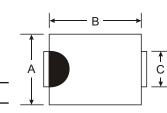
Features

Glass Passivated Die Construction Super-Fast Recovery Time For High Efficiency Surge Overload Rating to 50A Peak Ideally Suited for Automated Assembly Lead Free Finish/RoHS Compliant (Note 4)

Mechanical Data

Case: SMB

Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 1 per J-STD-020C Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (@3) Polarity: Cathode Band or Cathode Notch Marking Information: See Page 3 Ordering Information: See Page 3



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SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
С	1.96	2.21		
D	0.15	0.31		
Е	5.00	5.59		
G	0.10	0.20		
н	0.76	1.52		
J	2.00	2.62		
All Dimensions in mm				

Maximum Ratings and Electrical Characteristics @ T_A = 25 C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Weight: 0.093 grams (approximate)

Characteristic		Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 5)	V _{RRM} V _{RWM} V _R	400	V
RMS Reverse Voltage	V _{R(RMS)}	280	V
Average Rectified Output Current @ $T_T = 110$	C I _O	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load		50	А
Forward Voltage @ I _F = 2.0	A V _{FM}	1.25	V
Peak Reverse Current@ $T_A = 25$ at Rated DC Blocking Voltage (Note 5)@ $T_A = 125$		5.0 350	A
Reverse Recovery Time (Note 3)	t _{rr}	35	ns
Typical Capacitance (Note 2)	CT	25	pF
Typical Thermal Resistance, Junction to Terminal (Note 1)		20	°C/W
Operating and Storage Temperature Range		-55 to +150	С

Notes: 1. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

3. Measured with I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A. See Figure 5.

4. RoHS revision 13.2.2003. Glass and high temperature solder exemptions applied, see EU Directive Annex Notes 5 and 7.

5. Short duration pulse test used to minimize self-heating effect



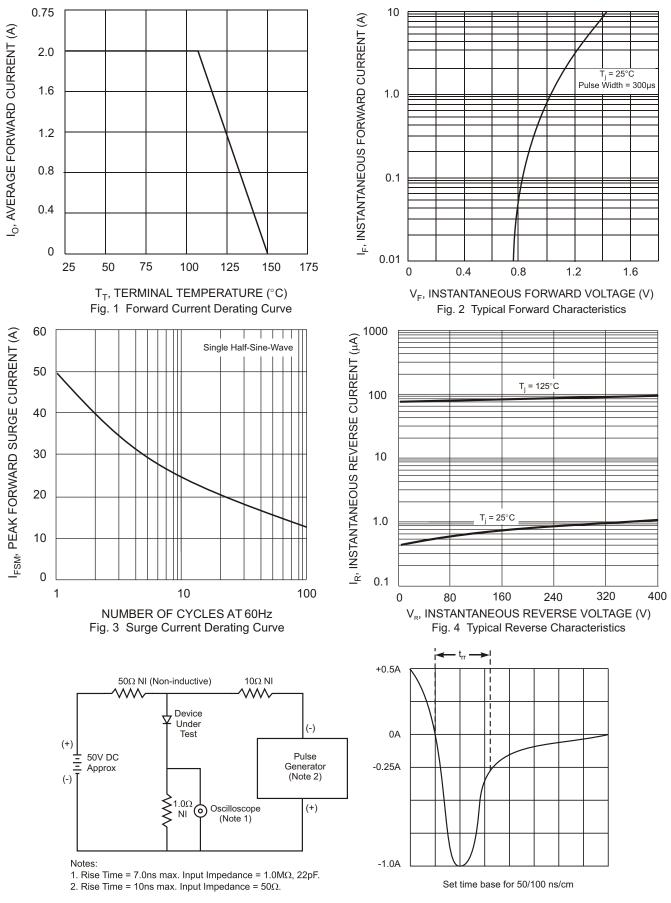


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



Ordering Information (Note 6)

Device	Packaging	Shipping
ES2G-13-F	SMB	5000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



ES2G = Product type marking code) | = Manufacturers' code marking YWW = Date code marking Y = Last digit of year ex: 2 for 2002 WW = Week code 01 to 52

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